



Distribution board BI-7654 incl. modular DIN insert



Part no. **MDB-BI-7654/SKAP/DIN**
Catalog No. **180434**

EL-Nummer (Norway) **1706016**

Design verification as per IEC/EN 61439

Technical data for design verification			
Heat dissipation, at an ambient temperature of 35°C, delta T: 20 degrees in top of the enclosure, calculated as per IEC 60890			
Individual enclosure for wall mounting	P _V	W	66
Starting enclosure for wall mounting	P _V	W	63
Middle enclosure for wall mounting	P _V	W	61
Heat dissipation, at an ambient temperature of 35°C, delta T: 35 degrees in top of the enclosure, calculated as per IEC 60890			
Individual enclosure for wall mounting	P _V	W	133
Starting enclosure for wall mounting	P _V	W	127
Middle enclosure for wall mounting	P _V	W	122
IEC/EN 61439 design verification			
10.2 Strength of materials and parts			
10.2.2 Corrosion resistance			Meets the product standard's requirements.
10.2.3.1 Verification of thermal stability of enclosures			Meets the product standard's requirements.
10.2.3.2 Verification of resistance of insulating materials to normal heat			Meets the product standard's requirements.
10.2.3.3 Verification of resistance of insulating materials to abnormal heat and fire due to internal electric effects			Meets the product standard's requirements.
10.2.4 Resistance to ultra-violet (UV) radiation			Not relevant to indoor installations.
10.2.5 Lifting			Does not apply to enclosures without lifting aids.
10.2.6 Mechanical impact			IK08
10.2.7 Inscriptions			Meets the product standard's requirements.
10.3 Degree of protection of ASSEMBLIES			IP30
10.4 Clearances and creepage distances			Is the panel builder's responsibility.
10.5 Protection against electric shock			< 0.1 Ω; meets the product standard's requirements.
10.6 Incorporation of switching devices and components			Is the panel builder's responsibility.
10.7 Internal electrical circuits and connections			Is the panel builder's responsibility.
10.8 Connections for external conductors			Is the panel builder's responsibility.
10.9 Insulation properties			
10.9.2 Power-frequency electric strength			U _i = 1890 V AC
10.9.3 Impulse withstand voltage			2.5 kV
10.9.4 Testing of enclosures made of insulating material			Does not apply to metal enclosures.
10.10 Temperature rise			The panel builder is responsible for the temperature rise calculation. Eaton will provide heat dissipation data for the devices.
10.11 Short-circuit rating			Is the panel builder's responsibility. The specifications for the switchgear must be observed.
10.12 Electromagnetic compatibility			Is the panel builder's responsibility. The specifications for the switchgear must be observed.
10.13 Mechanical function			Meets the product standard's requirements.

Technical data ETIM 7.0

Distribution boards (EG000023) / Small distribution board (EC000214)		
Electric engineering, automation, process control engineering / Electrical installation, device / Electrical distribution system (incl. small distribution board) / Small distribution board (ecl@ss10.0.1-27-14-24-09 [ACN387011])		
Mounting method		Surface mounted (plaster)
Number of rows		5
Width in number of modular spacings		24
Type of cover		Door

Cover model			Closed
Transparent cover/door			No
Material housing			Steel
Height		mm	765
Width		mm	545
Depth		mm	220
Built-in depth		mm	212
Internal depth		mm	210
DIN-rail			Yes
With mounting plate			No
Extension possible			No
EMC-version			Yes
Colour			White
RAL-number			9016
Degree of protection (IP)			IP30
With lock			No
Type of closure			Other